

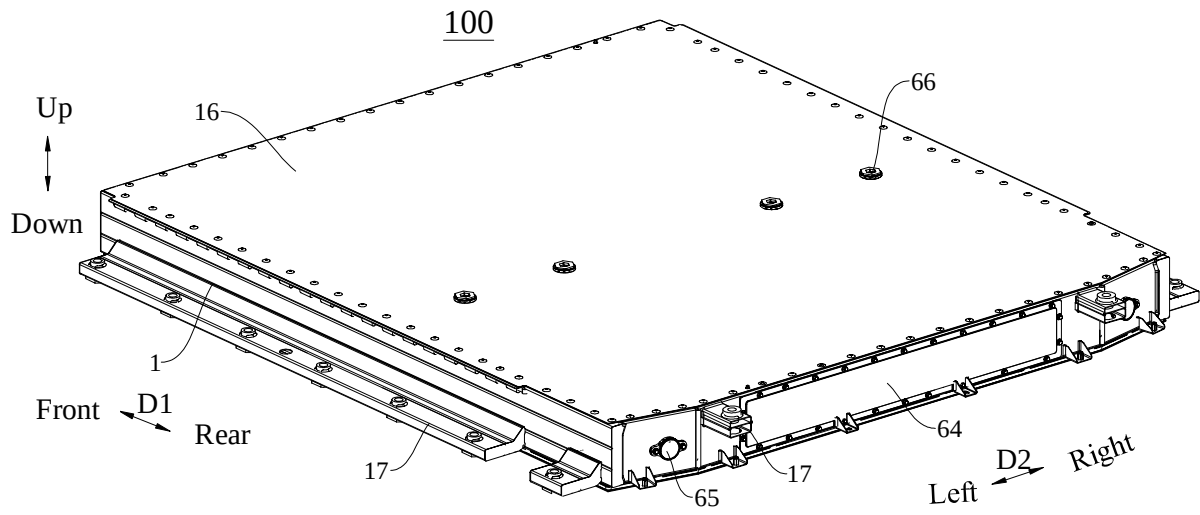


FIG. 1

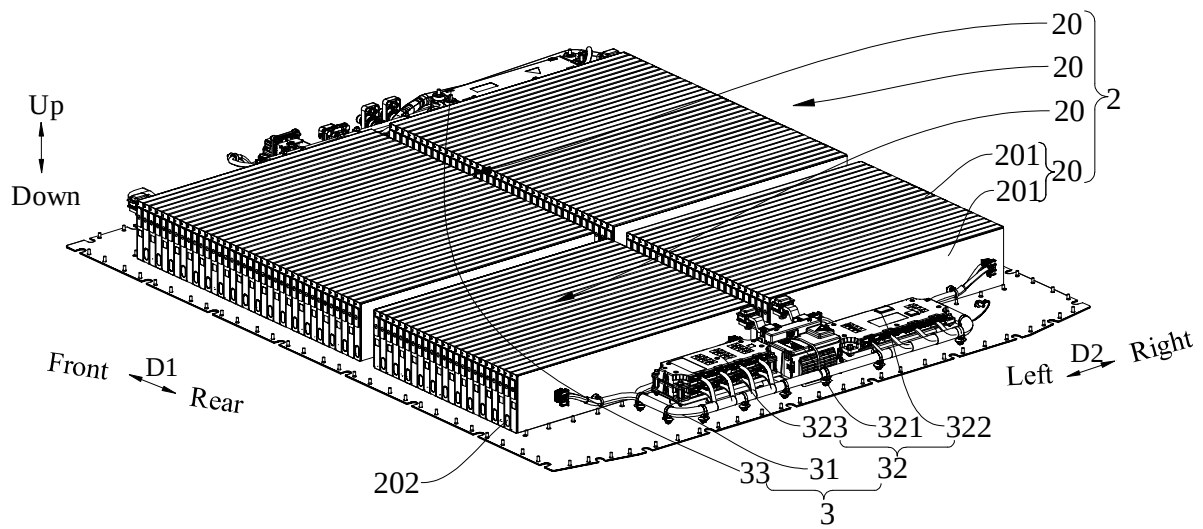
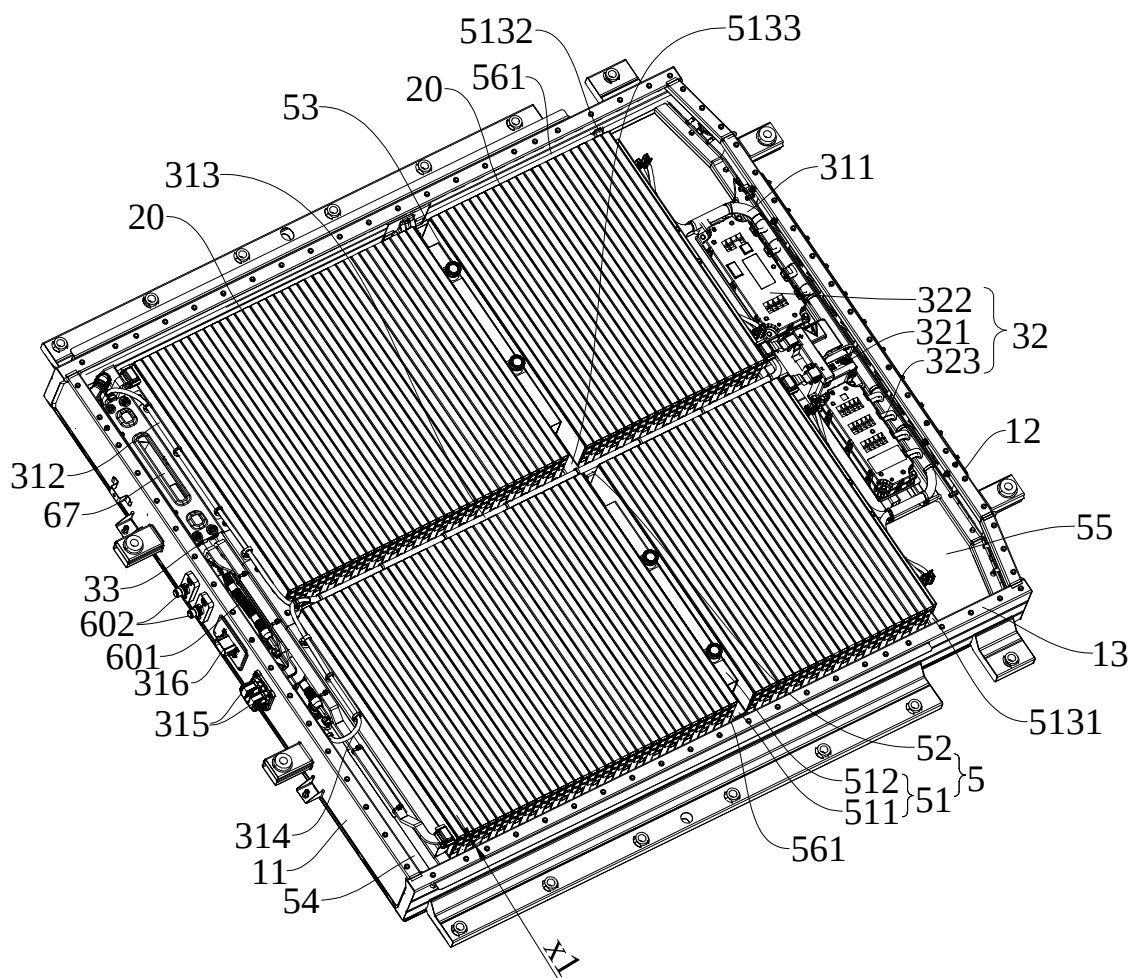
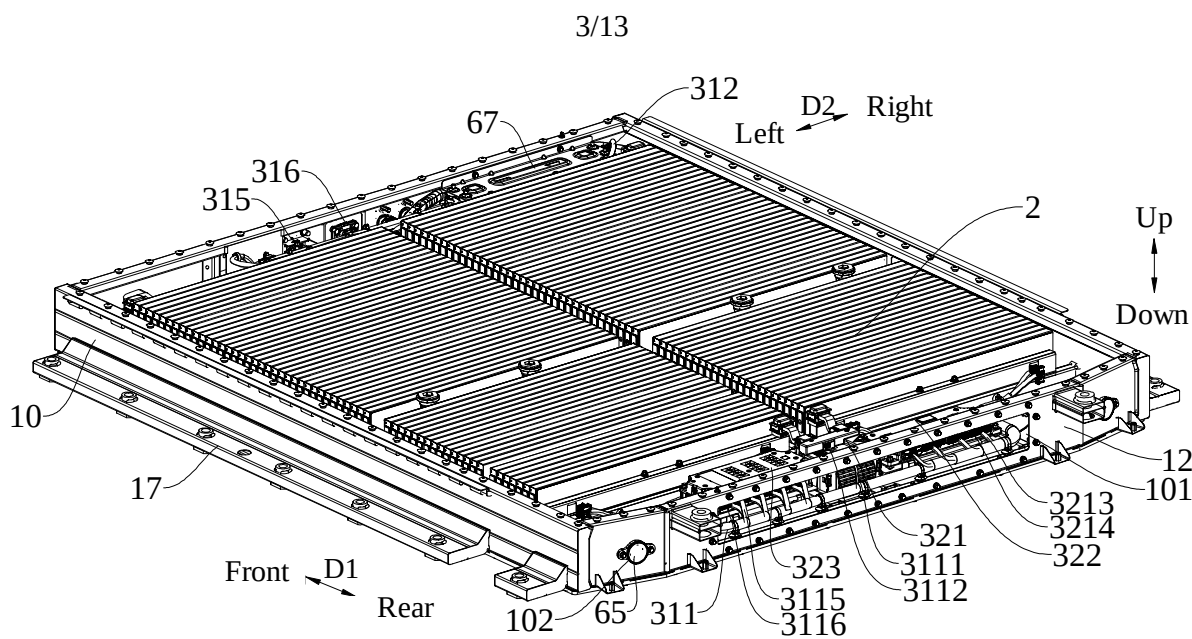


FIG. 2





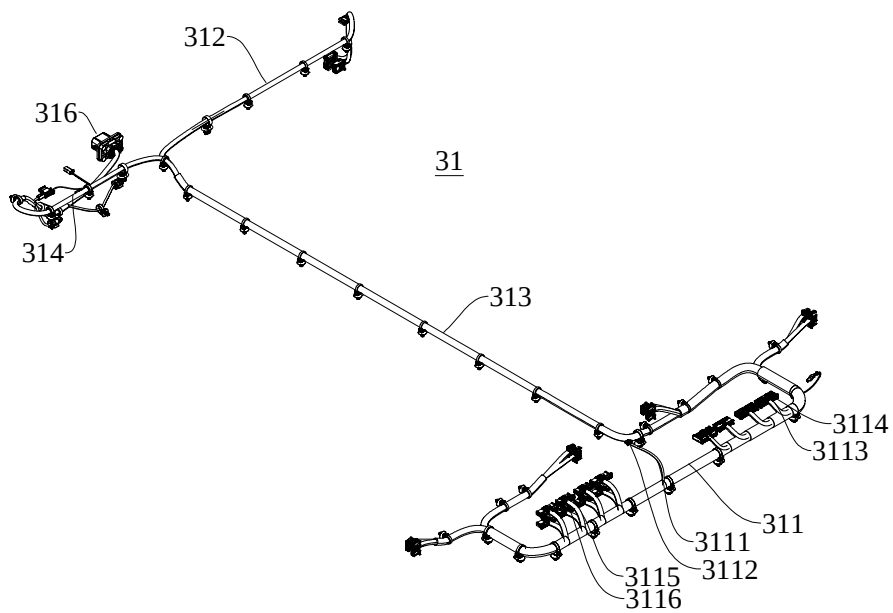


FIG. 7

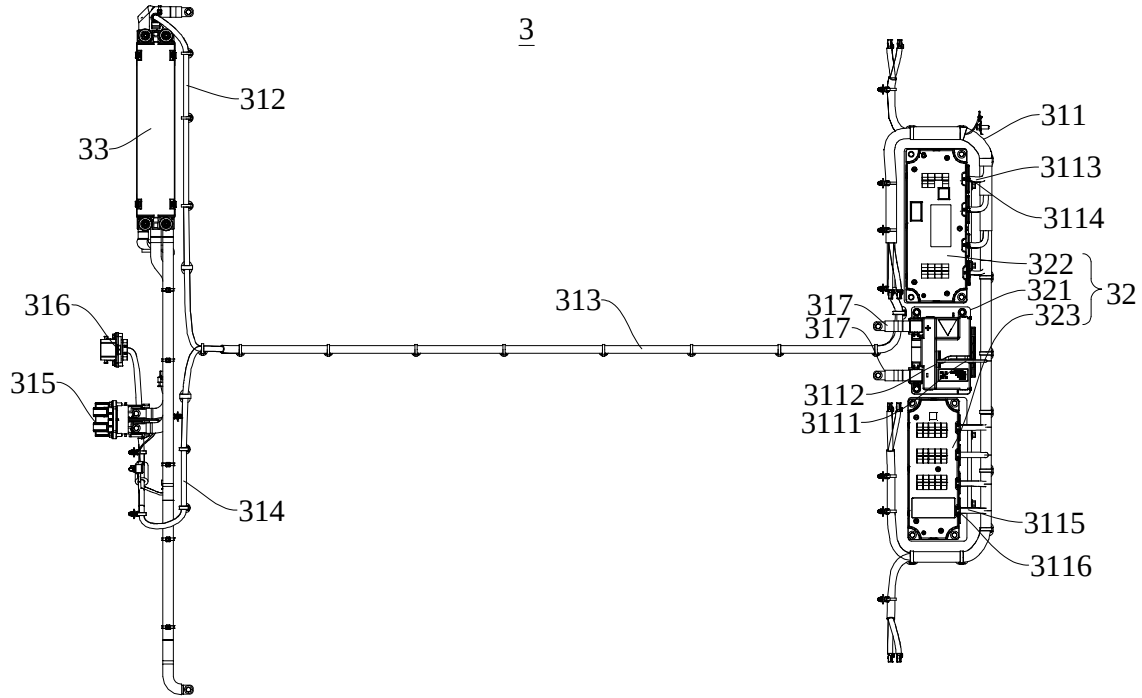


FIG. 8

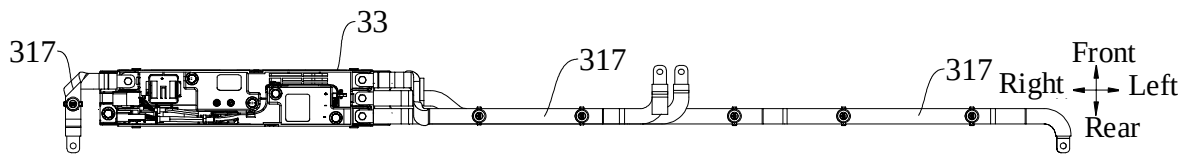


FIG. 9

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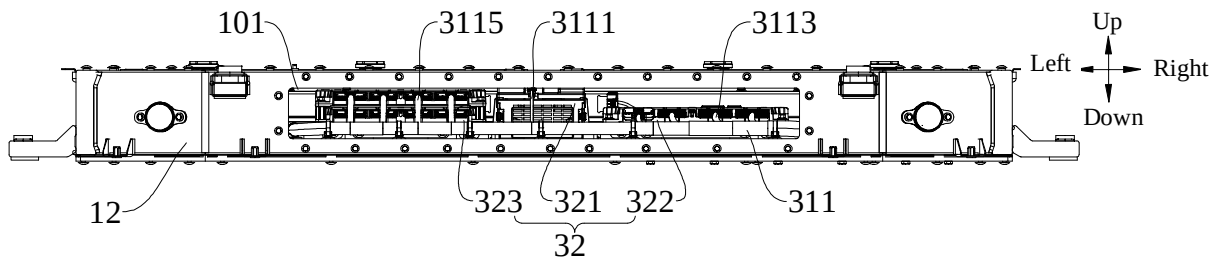


FIG. 10

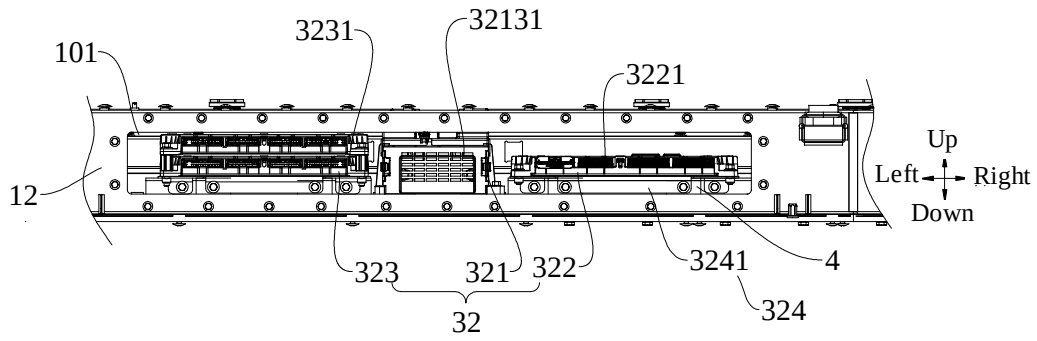


FIG. 11

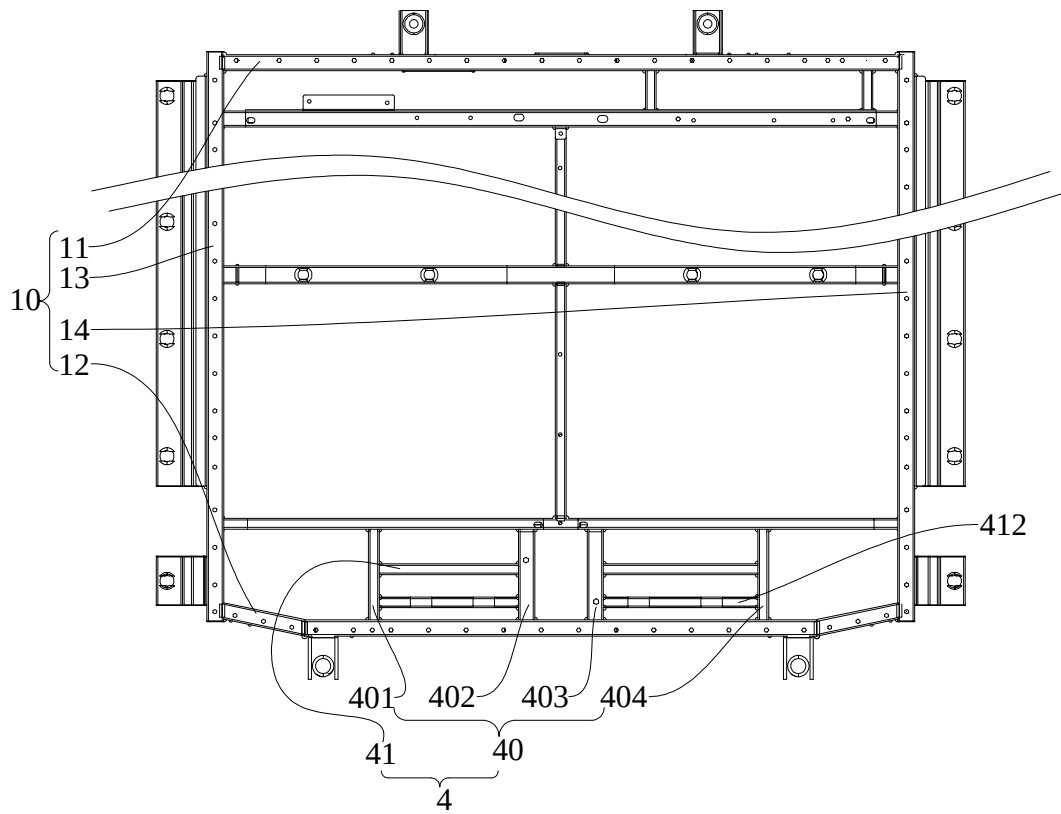


FIG. 12

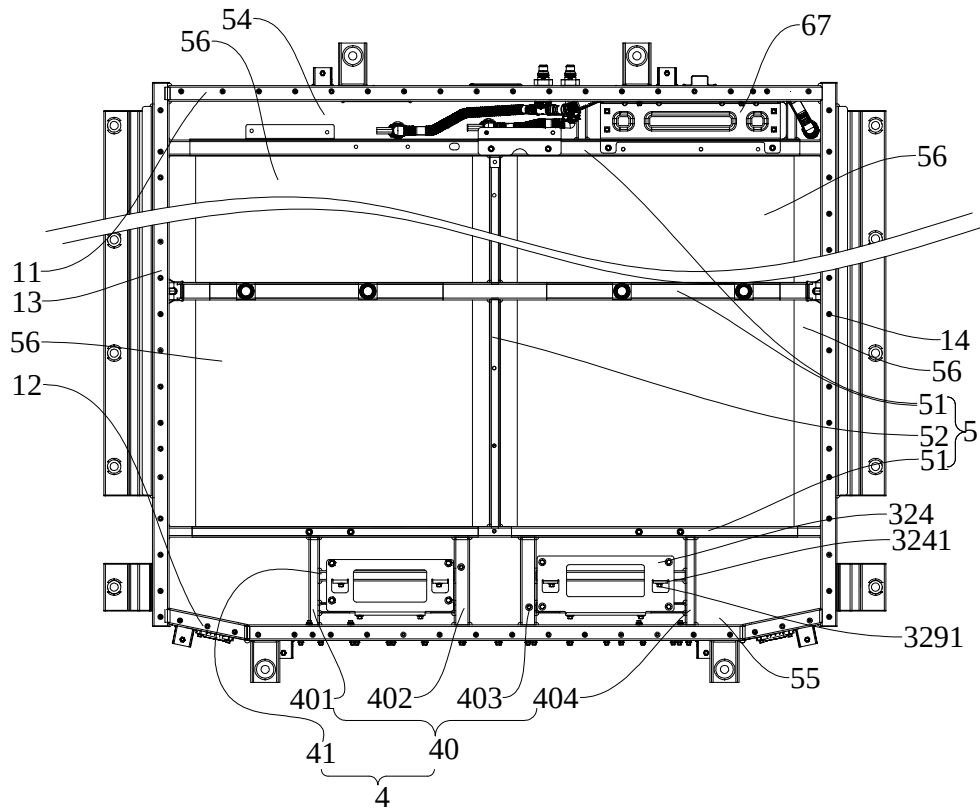


FIG. 13

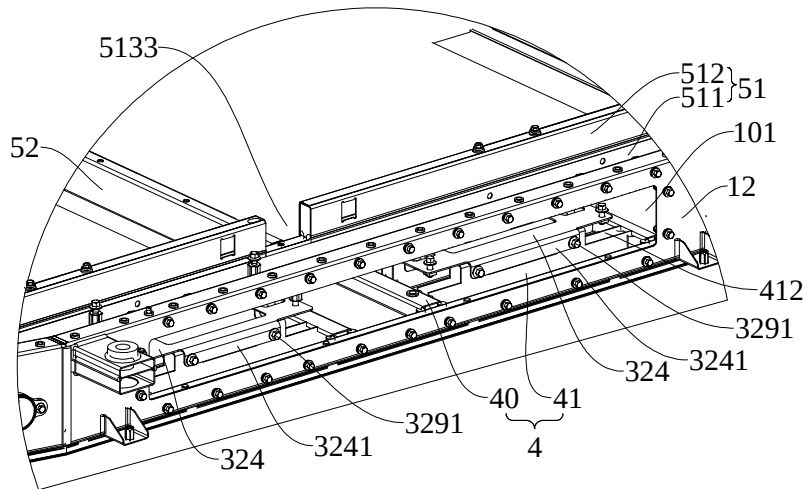


FIG. 14

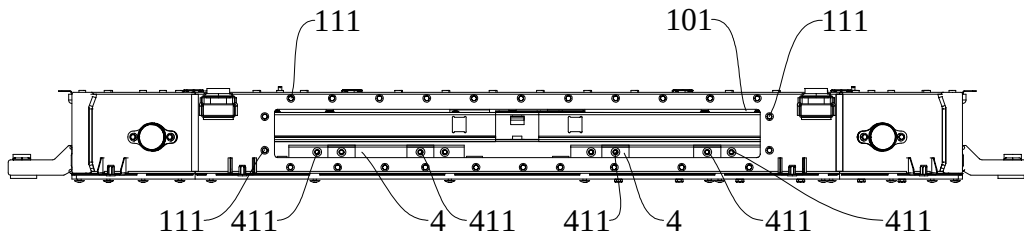


FIG. 15

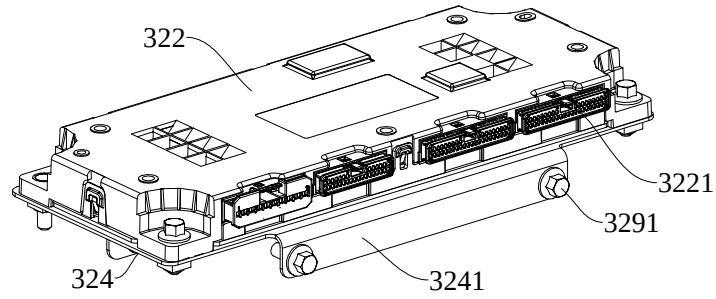


FIG. 16

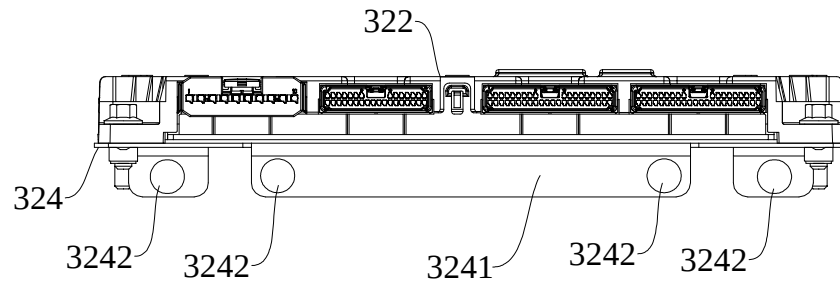


FIG. 17

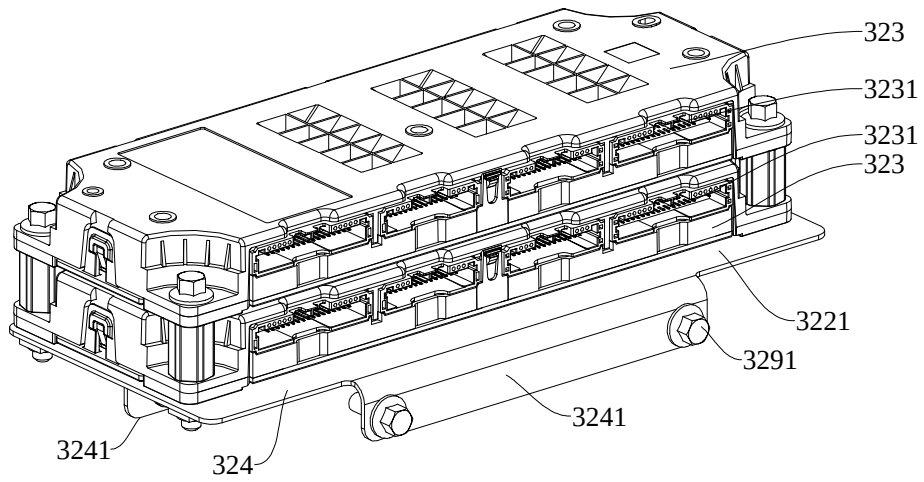


FIG. 18

Figure 1 is a perspective view of a multi-layer printed circuit board (PCB) assembly 321. The assembly includes a base layer 3211, a middle layer 3212, and a top layer 3213. A front panel 3217 is attached to the front of the assembly. The front panel 3217 has a grid of rectangular openings 3217a. The assembly is mounted on a base 3211 with four legs 3211a. The assembly is oriented with Front, Rear, Left, and Right directions indicated. A vertical arrow indicates Up and Down directions.

FIG. 20

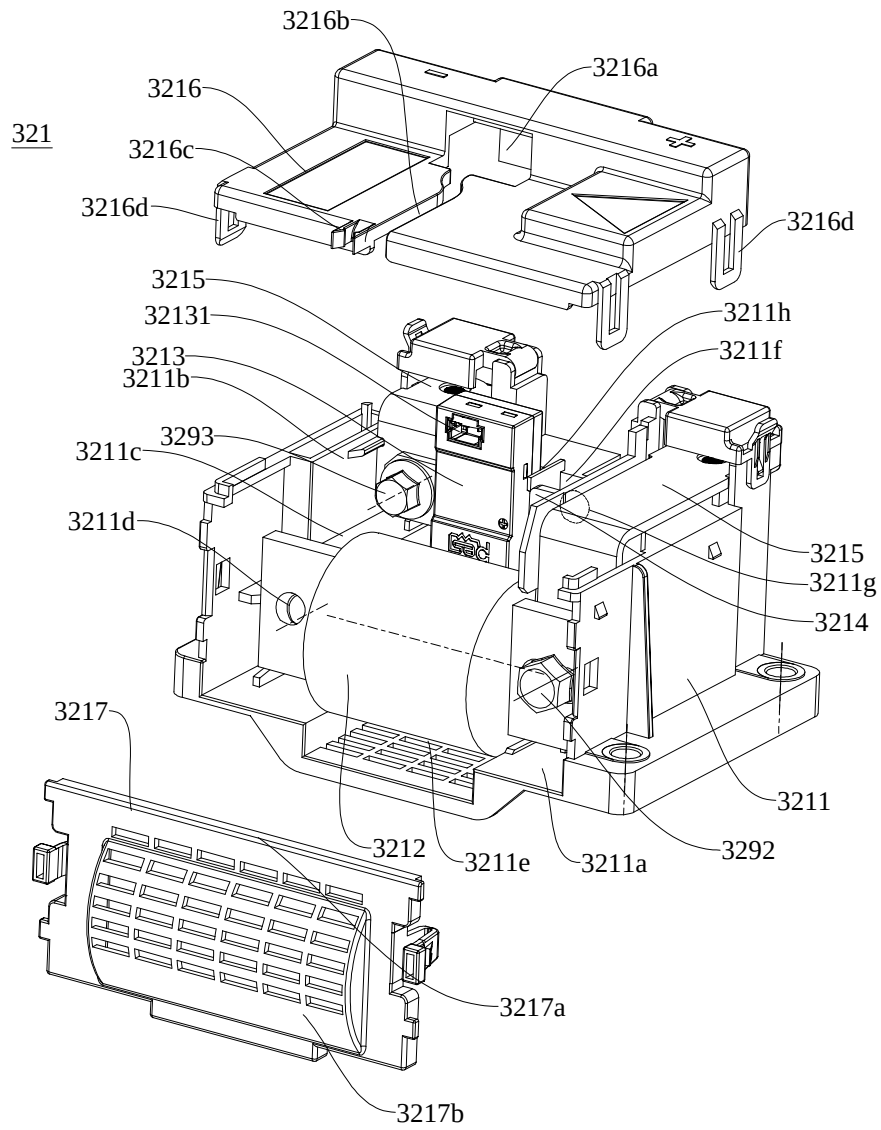


FIG. 21

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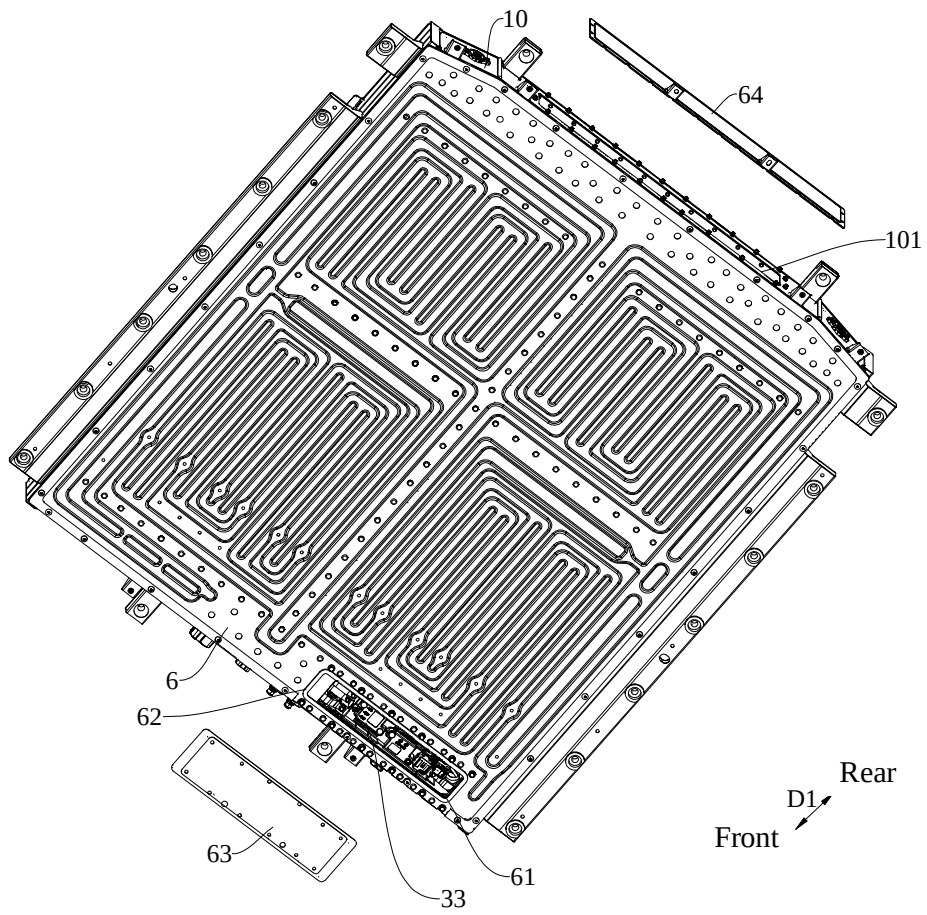


FIG. 22

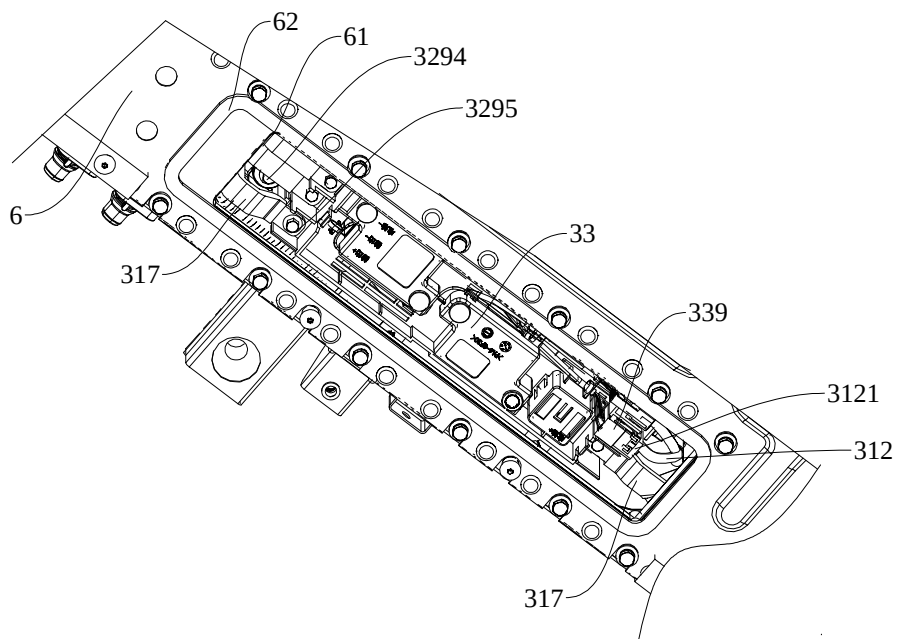


FIG. 23

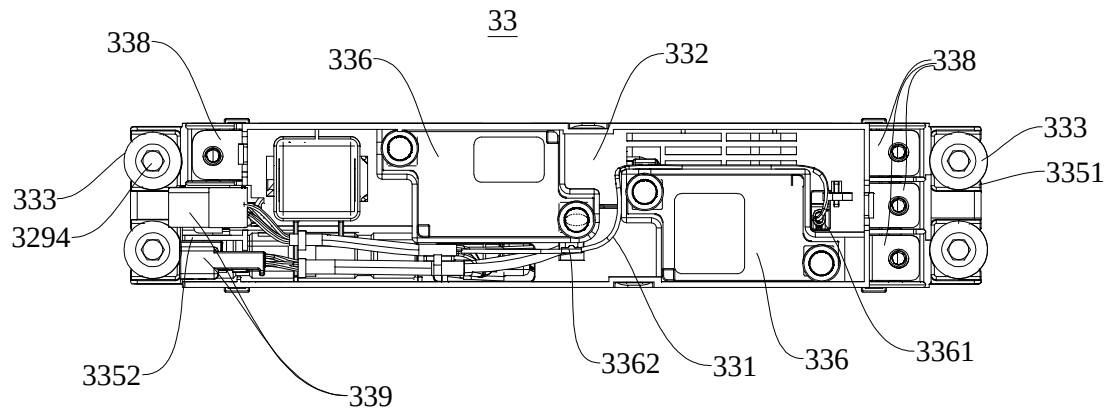


FIG. 24

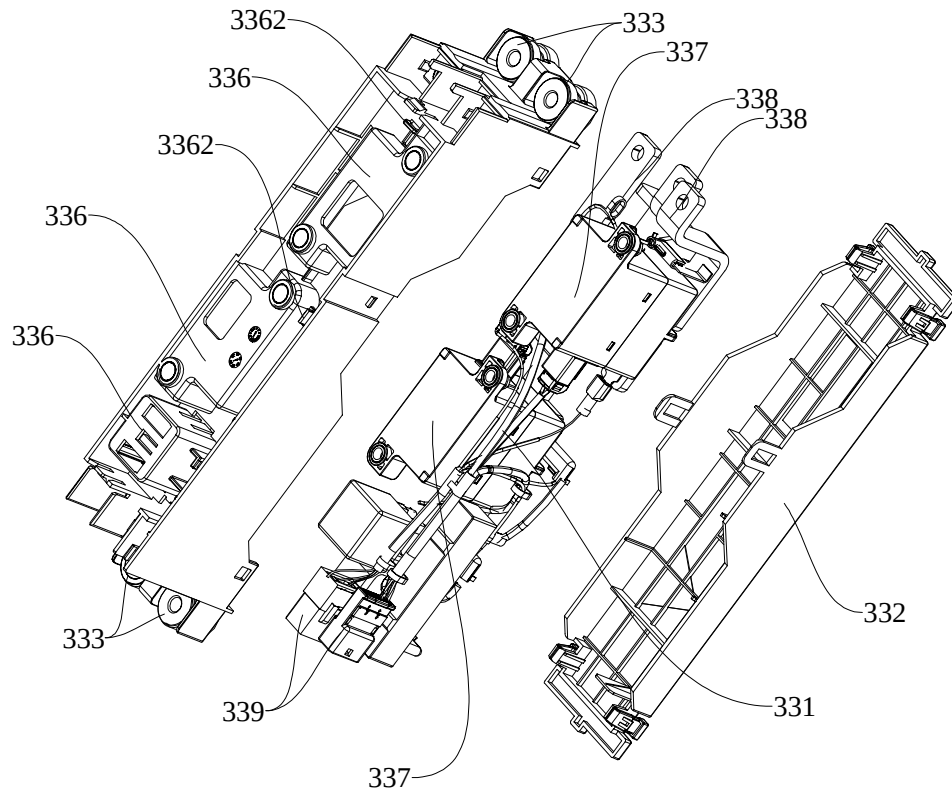


FIG. 25

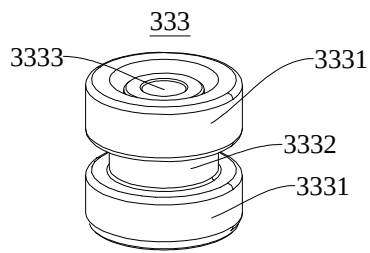


FIG. 26

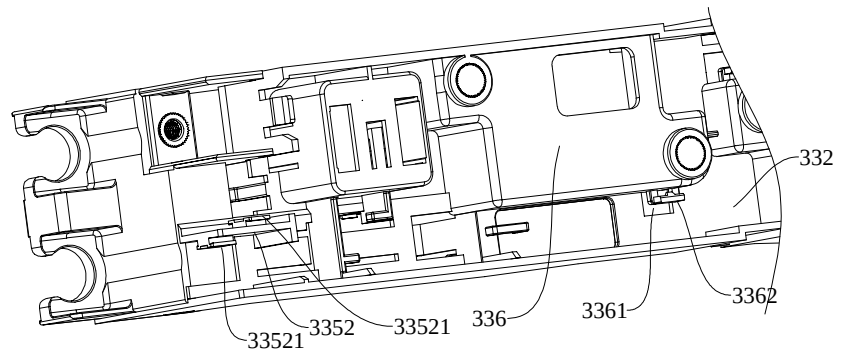


FIG. 27

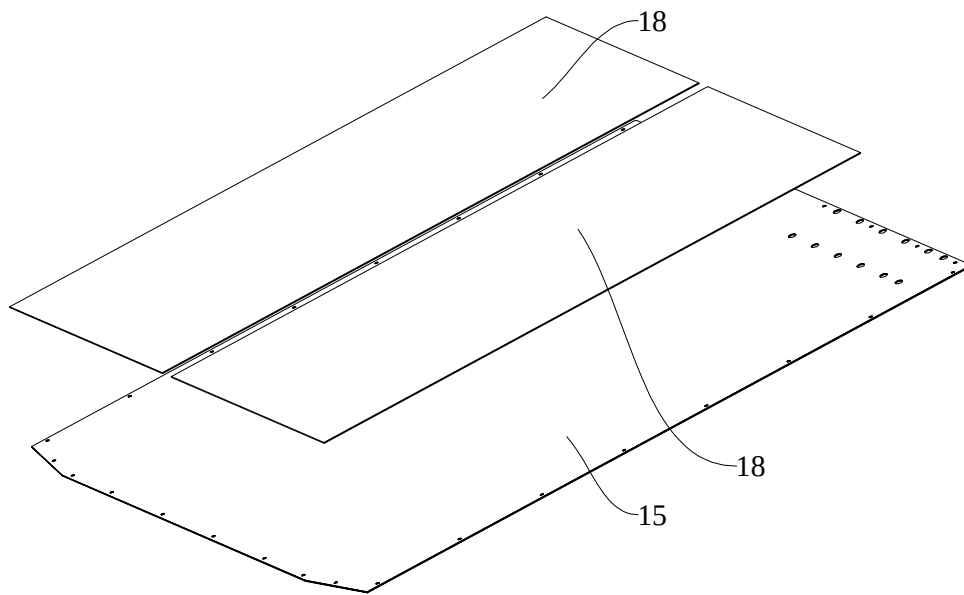


FIG. 28

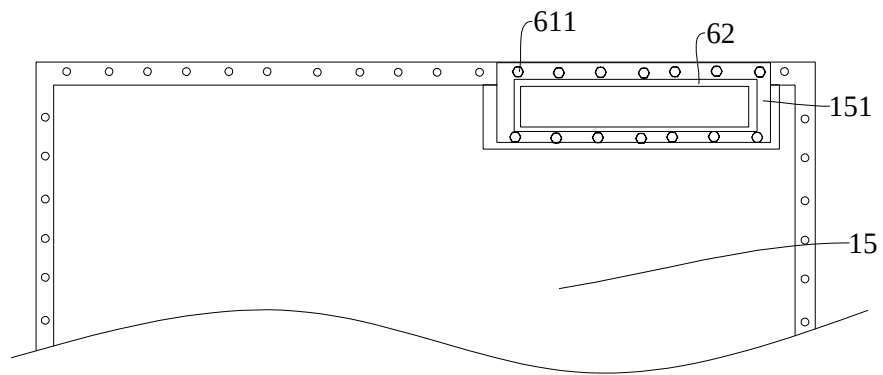


FIG. 29

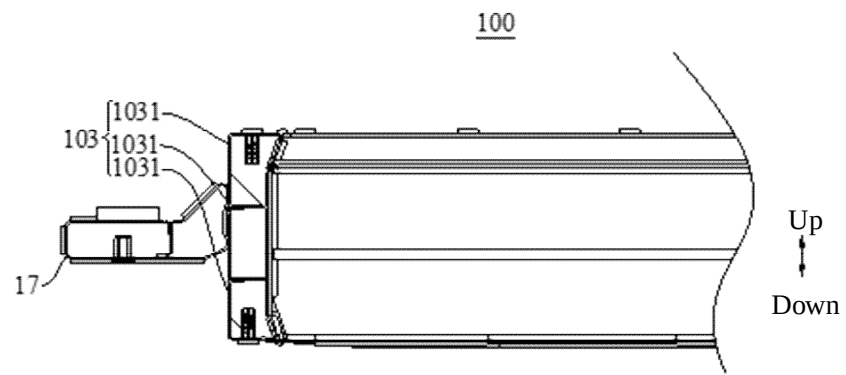


FIG. 30

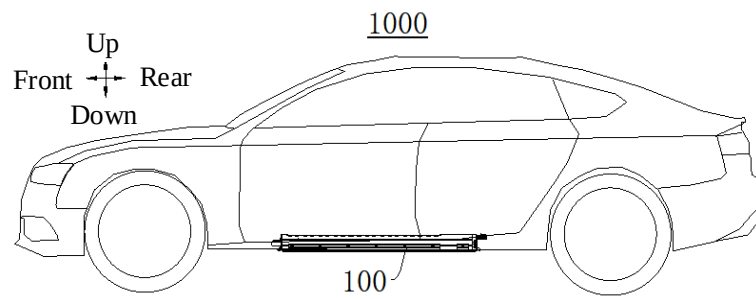


FIG. 31

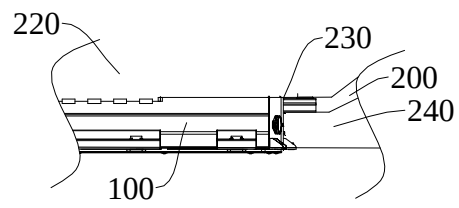


FIG. 32